



BSI Standards Publication

Test methods for electrical materials, circuit boards and other interconnection structures and assemblies

Part 2-809: X/Y coefficient of thermal expansion
(CTE) test for thick base materials by TMA

National foreword

This British Standard is the UK implementation of EN IEC 61189-2-809:2025. It is identical to IEC 61189-2-809:2024.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its committee manager.

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